

### **General Description**

The MAX13410E-MAX13415E are half-duplex RS-485-/RS-422-compatible transceivers optimized for isolated applications. These devices feature an internal low-dropout regulator (LDO), one driver, and one receiver. The internal LDO allows the part to operate from an unregulated power supply of up to 28V. The AutoDirection feature reduces the number of optical isolators needed in isolated applications. Other features include enhanced ESD protection, fail-safe circuitry, slew-rate limiting, and fullspeed operation.

The MAX13410E-MAX13415E internal LDO generates a 5V ±10% power supply that is used to power its internal circuitry. The MAX13412E-MAX13415E bring the 5V to an output VREG that allows the user to power additional external circuitry with up to 20mA to further reduce external components. The MAX13410E/MAX13411E do not have a 5V output and come in industry-compatible pinouts. This allows easy replacement in existing designs.

The MAX13410E-MAX13415E feature a 1/8-unit load receiver input impedance, allowing up to 256 transceivers on the bus. All driver outputs are ESD protected using the Human Body Model. These devices also include fail-safe circuitry (MAX13410E/MAX13411E/ MAX13414E/MAX13415E only), guaranteeing a logichigh receiver output when the receiver inputs are open or shorted. The receiver outputs a logic-high when the transmitter on the terminated bus is disabled (high impedance).

The MAX13412E/MAX13413E feature Maxim's proprietary AutoDirection control. This architecture eliminates the need for the DE and RE control signals. In isolated applications, this reduces the cost and size of the system by reducing the number of optical isolators required.

The MAX13410E/MAX13412E/MAX13414E feature reduced slew-rate drivers that minimize EMI and reduce reflections caused by improperly terminated cables, allowing error-free transmission up to 500kbps. The MAX13411E/MAX13413E/MAX13415E are not slew-rate limited, allowing transmit speeds up to 16Mbps.

The MAX13410E-MAX13415E are available in an 8-pin SO package with an exposed paddle to improve power dissipation, and operate over the extended -40°C to +85°C temperature range.

#### **Features**

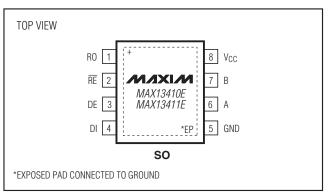
- ♦ Wide +6V to +28V Input Supply Range
- ♦ +5V Output Supplies Up to 20mA to External Circuitry
- **♦ Internal LDO**
- ♦ Low 65µA (typ) Shutdown Supply Current
- **♦ Extended ESD Protection** ±15kV Human Body Model (MAX13412E/ MAX13413E) ±14kV Human Body Model (MAX13410E/ MAX13411E)
- ♦ 1/8-Unit Load, Allowing Up to 256 Transceivers on the Bus
- ◆ -40°C to +85°C Operating Temperature Range
- ♦ Fail-Safe
- **♦ Slew-Rate Limited and Full-Speed Versions**
- ♦ Up to 16Mbps Data Rate on Full-Speed Versions

### **Applications**

Isolated RS-485 Interfaces **Utility Meters** 

Industrial Equipment Telecomm Equipment

# Pin Configurations



Pin Configurations continued at end of data sheet.

# Ordering Information/Selector Guide

PART PIN-PACKAGE		AutoDirection	DATA RATE (max)	5V LDO OUTPUT
MAX13410EESA+	8 SO-EP*	No	500kbps	No
MAX13411EESA+	8 SO-EP*	No	16Mbps	No

Note: All devices operate over the -40°C to +85°C operating temperature range.

+Denotes a lead(Pb)-free/RoHS-compliant package.

\*EP = Exposed pad.

Ordering Information/Selector Guide continued at end of data

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#### **ABSOLUTE MAXIMUM RATINGS**

(All voltages referenced to GND.)		Operating Temperate
Vcc	0.3V to +30V	Storage Temperature
RE, DE/RE, DE, DI, RO, V <sub>REG</sub>	0.3V to +6V	Junction Temperatur
A, B		θ <sub>JA</sub> (Note 1)
Short-Circuit Duration (RO, A, B) to GND	Continuous	θ <sub>JC</sub> (Note 1)
Continuous Power Dissipation ( $T_A = +70^{\circ}C$ )		Lead Temperature (s
8-Pin SO-EP (derate 19.2mW/°C above +7	'0°C)1539mW	

Operating Temperature Range	40°C to +85°C
Storage Temperature Range	65°C to +150°C
Junction Temperature	+150°C
θ <sub>JA</sub> (Note 1)	52.0°C/W
θ <sub>JC</sub> (Note 1)	6.0°C/W
Lead Temperature (soldering, 10	s)+300°C

Note 1: Package thermal resistances were obtained using the method described in JEDEC specificactions JESD51-7 using a four layer board. For detailed information on package consitencies refer to www.maxim-ic/thermal-tutorial.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### **ELECTRICAL CHARACTERISTICS**

 $(V_{CC} = +6.0V \text{ to } +28V, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted. Typical values are at } V_{CC} = +7.5V, C_S = 1\mu F, \text{ and } T_A = +25^{\circ}C.)$  (Note 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Supply Voltage	Vcc	(Note 3)	6.0		28.0	V
LDO Cutaut Valtage	\/p=0	$V_{CC} = +7.5V$ , $I_{LOAD} = 20mA$	4.5	5	5.5	· V
LDO Output Voltage	V <sub>REG</sub>	$V_{CC} = +28V$ , $I_{LOAD} = 0mA$	4.5	5	5.5	V
LDO Output Current	I <sub>REG</sub>	$V_{CC} > +7.5V$			20	mA
LDO Dropout Voltage	$V_{DO}$	$V_{CC} = +5V$ , $I_{OUT} = 20mA$		0.5		V
Minimum Bypass Capacitor on V <sub>REG</sub>	Cs	Guaranteed by design, MAX13412E–MAX13415E	1			μF
		RE, DE = high/no load (MAX13410E/MAX13411E)			10	
Supply Current	Icc	RE, DE/RE = high, DI = low/no load (MAX13412E-MAX13415E)			10	mA
Shutdown Current	I <sub>SHDN</sub>	DE = low, RE = high (MAX13410E/MAX13411E)		45		μA
Thermal-Shutdown Threshold	T <sub>TS</sub>			+150		°C
Thermal-Shutdown Threshold Hysteresis	T <sub>TSH</sub>			15		°C
DRIVER	•					•
		$R_{DIFF} = 100\Omega$ , Figure 1	2.0		5.5	
Differential Driver Output	V <sub>OD</sub>	$R_{DIFF} = 54\Omega$ , Figure 1	1.5		5.5	V
		No load			5.5	
Change in Magnitude of Differential Output Voltage	ΔV <sub>OD</sub>	$R_{\text{DIFF}} = 100\Omega$ or $54\Omega$ , Figure 1			0.2	V
Driver Common-Mode Output Voltage	Voc	$R_{\text{DIFF}} = 100\Omega$ or $54\Omega$ , Figure 1	1		3	V
Change In Magnitude of Common- Mode Voltage	ΔV <sub>OC</sub>	$R_{\text{DIFF}} = 100\Omega$ or $54\Omega$ , Figure 1			0.2	V
Input High Voltage	VIH	DI, DE, RE, DE/RE	2.0			V
Input Low Voltage	VIL	DI, DE, RE, DE/RE			0.8	V
Input Current	I <sub>IN</sub>	DI, DE, RE, DE/RE			±1	μA
Driver-Disable Threshold	V <sub>DT</sub>	$T_A = +25$ °C (MAX13412E/MAX13413E)	0.6		1.0	V

### **ELECTRICAL CHARACTERISTICS (continued)**

 $(V_{CC} = +6.0V \text{ to } +28V, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted. Typical values are at } V_{CC} = +7.5V, C_S = 1 \mu F, \text{ and } T_A = +25 ^{\circ}C.) \text{ (Note 2)}$ 

PARAMETER	SYMBOL	COND	ITIONS	MIN	TYP	MAX	UNITS
Driver Chart Circuit Outrast Correct	1	0V ≤ V <sub>OUT</sub> ≤ +12V				+250	A
Driver Short-Circuit Output Current	losp	-7V ≤ V <sub>OUT</sub> ≤ 0V		-250			mA
Driver Short-Circuit-Foldback Output	1	(V <sub>CC</sub> - 1V) ≤ V <sub>OUT</sub> ≤	<u>&lt;</u> +12V	20			^
Current	IOSDF	-7V <u>&lt;</u> V <sub>OUT</sub> <u>&lt;</u> 0V				-20	mA
RECEIVER				•			
Input Current (A and B)	I <sub>A, B</sub>	RE, DE, DE/RE =	V <sub>IN</sub> = +12V			125	μΑ
input ourient (/ varia b)	'А, Б	GND, V <sub>CC</sub> = GND	$V_{IN} = -7V$	-100			μπ
Receiver Differential Threshold	\/	-7V ≤ V <sub>CM</sub> ≤ +12V (MAX13410E/MAX1	3411E)	-200		-50	mV
Voltage	V <sub>TH</sub>	$-7V \le V_{LM} \le +12V$ (MAX13412E/MAX13	3413E)	-100		100	IIIV
Receiver Input Hysteresis	$\Delta V_{TH}$	$V_A + V_B = 0V$			15		mV
Output High Voltage	Voн	I <sub>O</sub> = -1mA, V <sub>A</sub> - V <sub>B</sub>	≥ VTH	V <sub>REG</sub> - 0.6	i		V
Output Low Voltage	V <sub>OL</sub>	$I_O = +1mA$ , $V_A - V_B$	≤-V <sub>TH</sub>			0.4	V
Three-State Output Current at Receiver	lozr	0 ≤ Vo ≤ VREG			0.01	±1	μΑ
Receiver-Input Resistance	R <sub>IN</sub>	-7V <u>&lt;</u> V <sub>CM</sub> <u>&lt;</u> +12V		96			kΩ
Receiver-Output Short-Circuit Current	IOSR	0V ≤ V <sub>RO</sub> ≤ V <sub>REG</sub>		±8		±95	mA
ESD PROTECTION							
ESD Protection (A, B)		Human Body Model (MAX13412E/MAX1			±15		kV
ESD Protection (A, B)		Human Body Model (MAX13410E/MAX1			±14		kV
ESD Protection (All Other Pins)		Human Body Model			±2		kV

#### **SWITCHING CHARACTERISTICS-MAX13410E**

 $(V_{CC} = +6.0 \text{V to} +28 \text{V}, T_A = T_{MIN} \text{ to} T_{MAX}, \text{ unless otherwise noted. Typical values are at } V_{CC} = +7.5 \text{V}, C_S = 1 \mu \text{F}, \text{ and } T_A = +25 ^{\circ} \text{C.}) \text{ (Note 2)}$ 

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
DRIVER						
Driver Presentian Delevi	tDPLH	$R_{DIFF} = 54\Omega$ , $C_L = 50pF$ ,	150		1000	
Driver Propagation Delay	tDPHL	Figures 2a and 3a	150		1000	ns
Driver Differential Output	t <sub>HL</sub>	$R_{DIFF} = 54\Omega$ , $C_L = 50pF$ ,	250		900	
Rise or Fall Time	t <sub>LH</sub>	Figures 2a and 3a	250		900	ns
Driver Differential Output Skew ItDPLH - tDPHLI	tDSKEW	$R_{DIFF}$ = 54 $\Omega$ , $C_L$ = 50pF, Figures 2a and 3a			140	ns
Maximum Data Rate	fMAX		500			kbps
Driver Enable from Shutdown to Output High	t <sub>DZH</sub> (SHDN)	S2 closed, Figure 4, R <sub>L</sub> = 500Ω, C <sub>L</sub> = 100pF			11	μs
Driver Enable from Shutdown to Output Low	tDZL(SHDN)	S2 closed, Figure 4, $R_L = 500\Omega$ , $C_L = 100pF$			6	μs

### **SWITCHING CHARACTERISTICS-MAX13410E (continued)**

 $(V_{CC} = +6.0V \text{ to } +28V, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted. Typical values are at } V_{CC} = +7.5V, C_S = 1\mu\text{F}, \text{ and } T_A = +25^{\circ}\text{C.})$  (Note 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Driver Enable to Output High	<sup>†</sup> DZH	S2 closed, Figure 4, R <sub>L</sub> = $500\Omega$ , C <sub>L</sub> = $100pF$			2500	ns
Driver Enable to Output Low	tDZL	S1 closed, Figure 4, R <sub>L</sub> = $500\Omega$ , C <sub>L</sub> = $100pF$			2500	ns
Driver Disable from Output High	t <sub>DHZ</sub>	S2 closed, Figure 4, R <sub>L</sub> = $500\Omega$ , C <sub>L</sub> = $100$ pF			100	ns
Driver Disable from Output Low	tDLZ	S1 closed, Figure 4, R <sub>L</sub> = $500\Omega$ , C <sub>L</sub> = $100$ pF			100	ns
Time to Shutdown	tshdn		50	340	700	ns
RECEIVER						
Receiver Propagation Delay	trplh	C: 15×5 (at DO) Figures 5 and C			200	ns
Theceiver i Topagation Delay	trphl	C <sub>L</sub> = 15pF (at RO), Figures 5 and 6			200	115
Receiver Output Skew	trskew	C <sub>L</sub> = 15pF (at RO), Figures 5 and 6			30	ns
Maximum Data Rate	fMAX		500			kbps
Receiver Enable to Output High	trzh	S2 closed, Figure 7, C <sub>L</sub> = 15pF			50	ns
Receiver Enable to Output Low	t <sub>RZL</sub>	S1 closed, Figure 7, C <sub>L</sub> = 15pF			50	ns
Receiver Disable Time from High	trzh	S2 closed, Figure 7, C <sub>L</sub> = 15pF			50	ns
Receiver Disable Time from Low	t <sub>RLZ</sub>	S1 closed, Figure 7, C <sub>L</sub> = 15pF			50	ns
Receiver Enable from Shutdown to Output High	t <sub>RZH</sub> (SHDN)	S2 closed, Figure 7, C <sub>L</sub> = 15pF			14	μs
Receiver Enable from Shutdown to Output Low	<sup>†</sup> RZL(SHDN)	S1 closed, Figure 7, C <sub>L</sub> = 15pF			3.5	μs

### **SWITCHING CHARACTERISTICS-MAX13411E**

 $(V_{CC} = +6.0 \text{V to } +28 \text{V}, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted.}$  Typical values are at  $V_{CC} = +7.5 \text{V}, C_S = 1 \mu F, \text{ and } T_A = +25 ^{\circ} C.)$  (Note 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
DRIVER						
Driver Propagation Delay	tDPLH	$R_{DIFF} = 54\Omega$ , $C_L = 50pF$ , Figures 2a			50	ns
Driver Fropagation Delay	tDPHL	and 3a			50	115
Driver Differential Output	tHL	$R_{DIFF} = 54\Omega$ , $C_L = 50pF$ , Figures 2a			15	ns
Rise or Fall Time	t <sub>LH</sub>	and 3a			15	118
Driver Differential Output Skew ltDPLH - tDPHLI	t <sub>DSKEW</sub>	$R_{DIFF}$ = 54 $\Omega$ , $C_L$ = 50pF, Figures 2a and 3a			8	ns
Maximum Data Rate	fMAX		16			Mbps
Driver Enable from Shutdown to Output High	t <sub>DZH</sub> (SHDN)	S2 closed, Figure 4, R <sub>L</sub> = 500Ω, C <sub>L</sub> = 100pF			11	μs
Driver Enable from Shutdown to Output Low	tDZL(SHDN)	S2 closed, Figure 4, R <sub>L</sub> = $500\Omega$ , C <sub>L</sub> = $100pF$			6	μs
Driver Enable to Output High	t <sub>DZH</sub>	S2 closed, Figure 4, $R_L = 500\Omega$ , $C_L = 100pF$			70	ns

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### **SWITCHING CHARACTERISTICS-MAX13411E (continued)**

 $(V_{CC} = +6.0 \text{V to } +28 \text{V}, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted.}$  Typical values are at  $V_{CC} = +7.5 \text{V}, C_S = 1 \mu\text{F}, \text{ and } T_A = +25 ^{\circ}\text{C}.)$  (Note 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Driver Enable to Output Low	tDZL	S1 closed, Figure 4, R <sub>L</sub> = $500\Omega$ , C <sub>L</sub> = $100$ pF			70	ns
Driver Disable from Output High	t <sub>DHZ</sub>	S2 closed, Figure 4, $R_L = 500\Omega$ , $C_L = 100pF$			50	ns
Driver Disable from Output Low	tDLZ	S1 closed, Figure 4, R <sub>L</sub> = $500\Omega$ , C <sub>L</sub> = $100pF$			50	ns
RECEIVER						
Desciver Presenting Delevi	trplh	C <sub>L</sub> = 15pF (at RO), Figures 5 and 6			75	
Receiver Propagation Delay	trphl				75	ns
Receiver Output Skew	trskew	C <sub>L</sub> = 15pF (at RO), Figures 5 and 6			8	ns
Maximum Data Rate	f <sub>MAX</sub>		16			Mbps
Receiver Enable to Output High	trzh	S2 closed, Figure 7, C <sub>L</sub> = 15pF			50	ns
Receiver Enable to Output Low	t <sub>RZL</sub>	S1 closed, Figure 7, C <sub>L</sub> = 15pF			50	ns
Receiver Disable Time from High	<sup>t</sup> RZH	S2 closed, Figure 7 , C <sub>L</sub> = 15pF			50	ns
Receiver Disable Time from Low	t <sub>RLZ</sub>	S1 closed, Figure 7, C <sub>L</sub> = 15pF			50	ns
Receiver Enable from Shutdown to Output High	<sup>t</sup> RZH(SHDN)	S2 closed, Figure 7, C <sub>L</sub> = 15pF			14	μs
Receiver Enable from Shutdown to Output Low	trzl(SHDN)	S1 closed, Figure 7, C <sub>L</sub> = 15pF			3.5	μs

### **SWITCHING CHARACTERISTICS-MAX13412E**

 $(V_{CC} = +6.0V \text{ to } +28V, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted. Typical values are at } V_{CC} = +7.5V, C_S = 1\mu\text{F}, \text{ and } T_A = +25^{\circ}\text{C.})$  (Note 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
DRIVER						
Driver Propagation Delay	tDPLH	$R_L = 110\Omega$ , $C_L = 50pF$ , Figures 2b	200		1000	20
Driver Propagation Delay	tDPHL	and 3b	200		1000	ns
Driver Differential Output	tHL	$R_L = 110\Omega$ , $C_L = 50pF$ , Figures 2b	250		900	20
Rise or Fall Time	t <sub>LH</sub>	and 3b	250		900	ns
Maximum Data Rate	fMAX		500			kbps
Driver Disable Delay	tDDD	$R_L = 110\Omega$ , $C_L = 50pF$ , Figure 3b			2500	ns
RECEIVER						
Descriver Properties Delev	trplh	C. 15p5 Figures 5 and C			200	
Receiver Propagation Delay	trphl	C <sub>L</sub> = 15pF, Figures 5 and 6			200	ns
Receiver Output Skew	trskew	C <sub>L</sub> = 15pF, Figures 5 and 6			30	ns
Maximum Data Rate	fMAX		500			kbps
Receiver Enable to Output High	trzh	S2 closed, Figure 7, C <sub>L</sub> = 15pF			50	ns
Receiver Enable to Output Low	t <sub>RZL</sub>	S1 closed, Figure 7, C <sub>L</sub> = 15pF			50	ns

### **SWITCHING CHARACTERISTICS-MAX13412E** (continued)

 $(V_{CC} = +6.0V \text{ to } +28V, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted. Typical values are at } V_{CC} = +7.5V, C_S = 1\mu F, \text{ and } T_A = +25^{\circ}C.)$  (Note 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Receiver Disable Time from Low	t <sub>RLZ</sub>	S1 closed, Figure 7, C <sub>L</sub> = 15pF			50	ns
Receiver Disable Time from High	trzh	S2 closed, Figure 7, C <sub>L</sub> = 15pF			50	ns
Receiver Enable Delay	t <sub>RED</sub>	$R_L = 110\Omega$ , $C_L = 50pF$ , Figure 3			2500	ns

#### **SWITCHING CHARACTERISTICS-MAX13413E**

 $(V_{CC} = +6.0V \text{ to } +28V, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted. Typical values are at } V_{CC} = +7.5V, C_S = 1\mu\text{F}, \text{ and } T_A = +25^{\circ}\text{C.})$  (Note 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
DRIVER						
Driver Propagation Delay	tDPLH	$R_L = 110\Omega$ , $C_L = 50pF$ , Figures 2b			50	ns
Driver Fropagation Delay	tDPHL	and 3b			50	115
Driver Differential Output	tHL	$R_L = 110\Omega$ , $C_L = 50pF$ , Figures 2b			15	20
Rise or Fall Time	tLH	and 3b			15	ns
Maximum Data Rate	f <sub>MAX</sub>		16			Mbps
Driver Disable Delay	tDDD	$R_L = 110\Omega$ , $C_L = 50$ pF, Figure 3b			70	ns
RECEIVER						
Bassiyer Propagation Dalay	t <sub>RPLH</sub>	C <sub>L</sub> = 15pF, Figures 5 and 6			80	200
Receiver Propagation Delay	t <sub>RPHL</sub>	CL = 15pr, rigures 5 and 6			80	ns
Receiver Output Skew	trskew	C <sub>L</sub> = 15pF, Figures 5 and 6			13	ns
Maximum Data Rate	f <sub>MAX</sub>		16			Mbps
Receiver Enable to Output High	trzh	S2 closed, Figure 7, C <sub>L</sub> = 15pF			50	ns
Receiver Enable to Output Low	t <sub>RZL</sub>	S1 closed, Figure 7, C <sub>L</sub> = 15pF			50	ns
Receiver Disable Time from Low	t <sub>RLZ</sub>	S1 closed, Figure 7, C <sub>L</sub> = 15pF			50	ns
Receiver Disable Time from High	trzh	S2 closed, Figure 7, C <sub>L</sub> = 15pF		•	50	ns
Receiver Enable Delay	t <sub>RED</sub>	$R_L = 110\Omega$ , Figure 3, $C_L = 50pF$			70	ns

### **SWITCHING CHARACTERISTICS-MAX13414E**

 $(V_{CC} = +6.0V \text{ to } +28V, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted. Typical values are at } V_{CC} = +7.5V, C_S = 1\mu F, \text{ and } T_A = +25^{\circ}C.)$  (Note 2)

PARAMETER	SYMBOL CONDITIONS		MIN	TYP MAX	UNITS
DRIVER					
Driver Propagation Delay	t <sub>DPLH</sub>	$R_{DIFF} = 54\Omega$ , $C_L = 50pF$ , Figures 2a	200	100	
Driver Fropagation Delay	tDPHL	and 3a	200	100	ns )
Driver Differential Output	tHL	$R_{DIFF} = 54\Omega$ , $C_L = 50pF$ , Figures 2a	250	900	no
Rise or Fall Time	t <sub>L</sub> H	and 3a	250	900	ns
Driver Differential Output Skew   ItDPLH - tDPHLI	tdskew	$R_{DIFF}$ = 54 $\!\Omega_{\rm h}$ , $C_L$ = 50 pF, Figures 2a and 3a		140	ns

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### **SWITCHING CHARACTERISTICS-MAX13414E (continued)**

 $(V_{CC} = +6.0 \text{V to } +28 \text{V}, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted.}$  Typical values are at  $V_{CC} = +7.5 \text{V}, C_S = 1 \mu F, \text{ and } T_A = +25 ^{\circ} C.)$  (Note 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	
Maximum Data Rate	f <sub>MAX</sub>		500			kbps	
Driver Enable to Output High	tDZH	S2 closed, Figure 4, R <sub>L</sub> = 500Ω C <sub>L</sub> = 100pF			2500	ns	
Driver Enable to Output Low	tDZL	S1 closed, Figure 4, R <sub>L</sub> = 500Ω C <sub>L</sub> = 100pF			2500	ns	
Driver Disable from Output High	tDHZ	S2 closed, Figure 4, R <sub>L</sub> = 500Ω, C <sub>L</sub> = 100pF			100	ns	
Driver Disable from Output Low	tDLZ	S1 closed, Figure 4, R <sub>L</sub> = 500Ω, C <sub>L</sub> = 100pF			100	ns	
RECEIVER							
Desciver Propagation Delay	trplh	C. 15pF (at DO) Figures 5 and 6			200	no	
Receiver Propagation Delay	trphl	C <sub>L</sub> = 15pF (at RO), Figures 5 and 6			200	ns	
Receiver Output Skew	trskew	C <sub>L</sub> = 15pF (at RO), Figures 5 and 6			30	ns	
Maximum Data Rate	f <sub>MAX</sub>		500			kbps	
Receiver Enable to Output High	trzh	S2 closed, Figure 7, C <sub>L</sub> = 15pF			50	ns	
Receiver Enable to Output Low	t <sub>RZL</sub>	S1 closed, Figure 7, C <sub>L</sub> = 15pF			50	ns	
Receiver Disable Time from Low	t <sub>RLZ</sub>	S1 closed, Figure 7, C <sub>L</sub> = 15pF			50	ns	
Receiver Disable Time from High	t <sub>RZH</sub>	S2 closed, Figure 7, C <sub>L</sub> = 15pF			50	ns	

### **SWITCHING CHARACTERISTICS-MAX13415E**

 $(V_{CC} = +6.0 \text{V to } +28 \text{V}, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted.}$  Typical values are at  $V_{CC} = +7.5 \text{V}, C_S = 1 \mu F, \text{ and } T_A = +25 ^{\circ} C.)$  (Note 2)

PARAMETER	SYMBOL CONDITIONS		MIN	TYP	MAX	UNITS
DRIVER						
Driver Propagation Delay	tDPLH	$R_{DIFF} = 54\Omega$ , $C_L = 50pF$ , Figures 2a			50	
Driver Propagation Delay	tDPHL	and 3a			50	ns
Driver Differential Output	tHL	$R_{DIFF} = 54\Omega$ , $C_L = 50pF$ , Figures 2a			15	ns
Rise or Fall Time	tLH	and 3a			15	115
Driver Differential Output Skew   ItDPLH - tDPHLI	tdskew	$R_{DIFF}$ = 54 $\Omega$ , $C_{L}$ = 50pF, Figures 2a and 3a			8	ns
Maximum Data Rate	fMAX		16			Mbps
Driver Enable to Output High	tDZH	S2 closed, Figure 4, R <sub>L</sub> = $500\Omega$ , C <sub>L</sub> = $15pF$			70	ns
Driver Enable to Output Low	t <sub>DZL</sub>	S1 closed, Figure 4, R <sub>L</sub> = $500\Omega$ , C <sub>L</sub> = $15pF$			70	ns
Driver Disable from Output High	tDHZ	S2 closed, Figure 4, R <sub>L</sub> = $500\Omega$ , C <sub>L</sub> = $15pF$			50	ns

### **SWITCHING CHARACTERISTICS-MAX13415E (continued)**

 $(V_{CC} = +6.0V \text{ to } +28V, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted. Typical values are at } V_{CC} = +7.5V, C_S = 1\mu\text{F}, \text{ and } T_A = +25^{\circ}\text{C.})$  (Note 2)

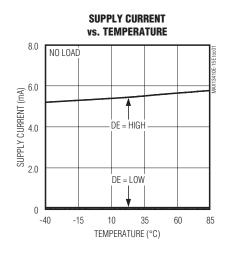
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Driver Disable from Output Low	t <sub>DLZ</sub>	S1 closed, Figure 4, $R_L = 500\Omega$ , $C_L = 15pF$			50	ns
RECEIVER						
Pagaiver Propagation Dolay	trplh	0 45-5 (-+ 00) 5:			75	no
Receiver Propagation Delay	trphl	C <sub>L</sub> = 15pF (at RO), Figures 5 and 6			75	ns
Receiver Output Skew	trskew	C <sub>L</sub> = 15pF (at RO), Figures 5 and 6			8	ns
Maximum Data Rate	f <sub>MAX</sub>		16			Mbps
Receiver Enable to Output High	trzh	S2 closed, Figure 7, C <sub>L</sub> = 15pF			50	ns
Receiver Enable to Output Low	t <sub>RZL</sub>	S1 closed, Figure 7, C <sub>L</sub> = 15pF			50	ns
Receiver Disable Time from Low	t <sub>RLZ</sub>	S1 closed, Figure 7, C <sub>L</sub> = 15pF			50	ns
Receiver Disable Time from High	trzh	S2 closed, Figure 7, C <sub>L</sub> = 15pF			50	ns

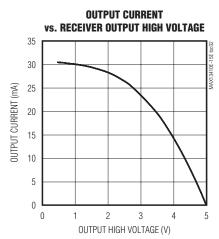
**Note 2:**  $C_S$  is the compensation capacitor on  $V_{REG}$  for the MAX13412E–MAX13415E versions.  $C_S$  must have an ESR value of  $20m\Omega$  or less.

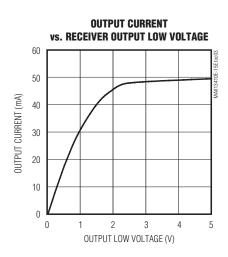
**Note 3:** Parameters are guaranteed for  $+6.0V \le V_{CC} \le +28V$ .

# Typical Operating Characteristics

 $(V_{CC} = +7.5V, T_A = +25^{\circ}C, unless otherwise noted.)$ 

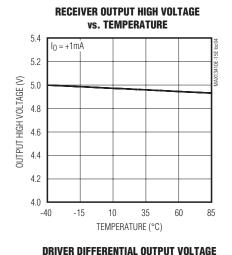


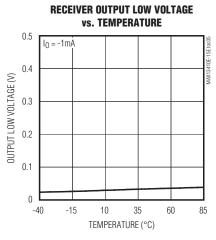


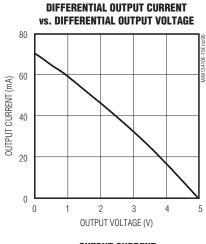


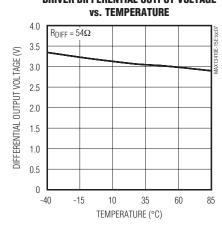
### Typical Operating Characteristics (continued)

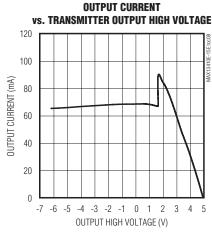
 $(V_{CC} = +7.5V, T_A = +25^{\circ}C, unless otherwise noted.)$ 

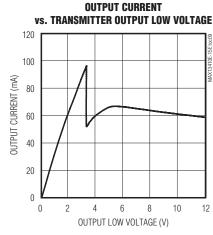


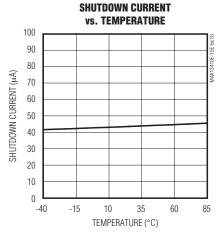


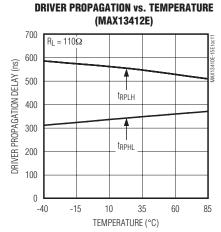


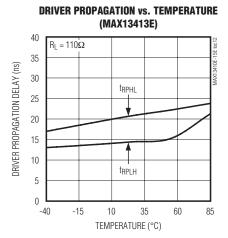






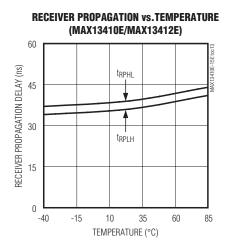


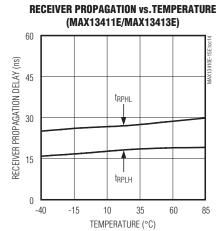


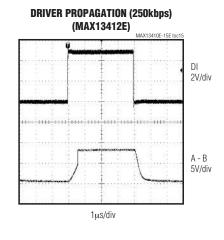


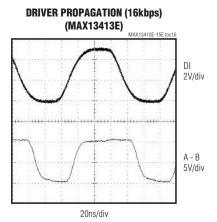
Typical Operating Characteristics (continued)

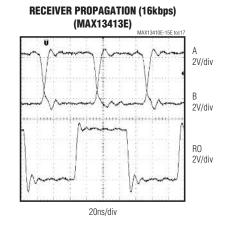
 $(V_{CC} = +7.5V, T_A = +25^{\circ}C, unless otherwise noted.)$ 

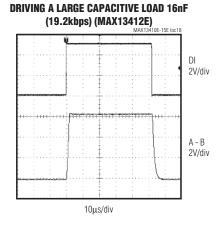


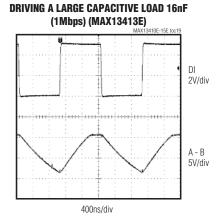


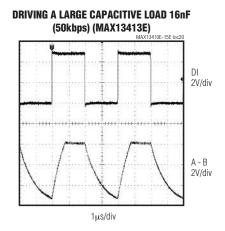












**Test Circuits and Waveforms** 

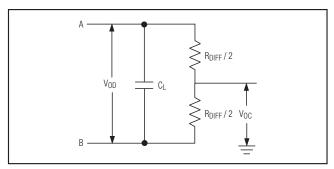


Figure 1. Driver DC Test Load

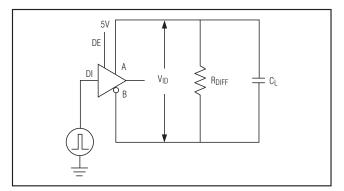


Figure 2a. Driver-Timing Test Circuit

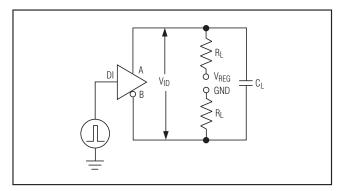


Figure 2b. Driver-Timing Test Circuit

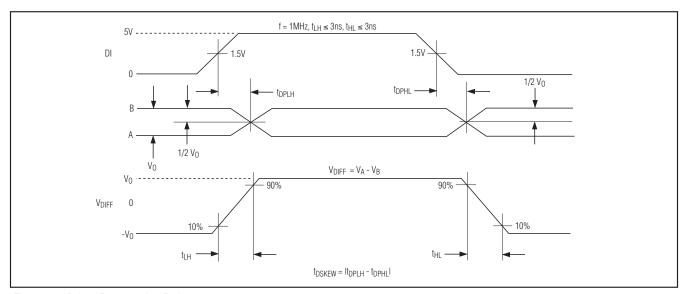


Figure 3a. Driver Propagation Delays

### Test Circuits and Waveforms (continued)

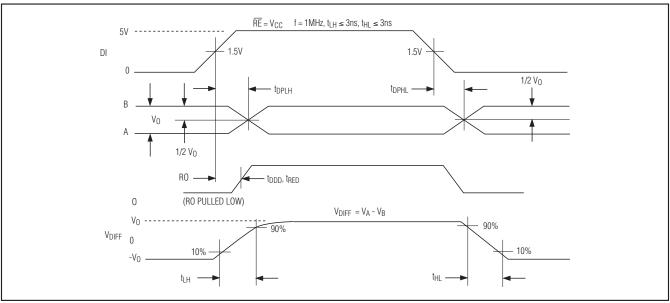


Figure 3b. Driver Propagation Delays

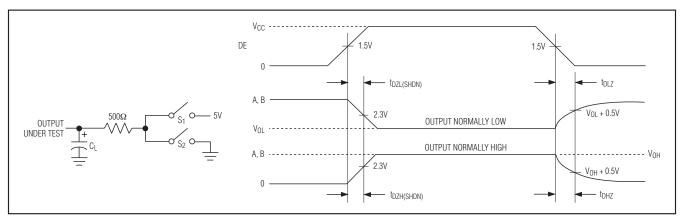


Figure 4. Driver Enable and Disable Times

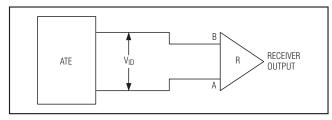


Figure 5. Receiver-Propagation-Delay Test Circuit

### Test Circuits and Waveforms (continued)

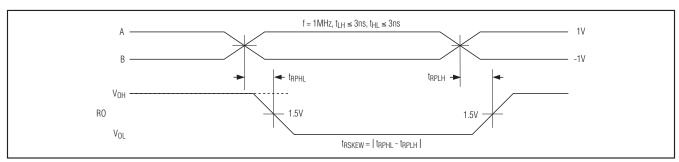


Figure 6. Receiver Propagation Delays

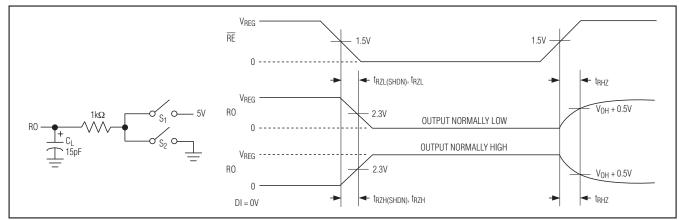


Figure 7. Receiver Enable and Disable Times

# Pin Description

	PIN		PIN			
MAX13410E/ MAX13411E	MAX13412E/ MAX13413E	MAX13414E/ MAX13415E	NAME	FUNCTION		
1	_	1	RO	Receiver Output. When receiver is enabled and $V_A$ - $V_B \ge$ -50mV, RO is high. If $V_A$ - $V_B \le$ -200mV, RO is low. <b>Note:</b> RO is referenced to the LDO output (V <sub>REG</sub> ).		
2	_	_	RE	Receiver Output Enable. Drive RE low to enable RO. Drive RE high to disable the RO output and put the RO output in a high-impedance state.		
3	_	_	DE	Driver Output Enable. Drive DE low to put the driver output in three-state.  Drive DE high to enable the driver.		
4	4	4	DI	Driver Input. Drive DI low to force the noninverting output low and the inverting output high. Drive DI high to force the noninverting output high and inverting output low. DI is an input to the internal state machine that automatically enables and disables the driver (for the MAX13412E/MAX13413E). See the function tables and <i>General Description</i> for more information.		
5	5	5	GND	Ground		
6	6	6	А	Noninverting Receiver Input and Noninverting Driver Output		
7	7	7	В	Inverting Receiver Input and Inverting Driver Output		
8	8	8	Vcc	Positive Supply. Bypass V <sub>CC</sub> with a 0.1µF ceramic capacitor to GND.		
_	1	_	RO	Receiver Output. When receiver is enabled and $V_A$ - $V_B \ge -100$ mV, RO is high. If $V_A$ - $V_B \le -100$ mV, RO is low. <b>Note:</b> RO is referenced to the LDO output ( $V_{REG}$ ).		
_	2	_	RE	Receiver Output Enable. Drive $\overline{\text{RE}}$ low to force the RO output to be enabled. Drive $\overline{\text{RE}}$ high to let the AutoDirection circuit control RO.		
_	3	3	VREG	LDO Output. $V_{REG}$ is fixed at +5V. Bypass $V_{REG}$ with a low ESR (20m $\Omega$ or less) and a 1 $\mu$ F (min) ceramic capacitor.		
_	_	2	DE/RE	Receiver and Driver Output Enable. Drive DE/RE low to enable RO and disable the driver. Drive DE/RE high to disable RO and enable the driver.		
EP	EP	EP	EP	Exposed Pad. EP is internally connected to GND. For enhanced thermal dissipation, connect EP to a copper area as large as possible. Do not use EP as a sole ground connection.		

### Function Tables for the MAX13410E/MAX13411E

TRANSMITTING							
INPUT OUTPUT							
RE	DE	DI	В А				
Х	1	1	0	1			
Х	1	0	1 0				
0	0	Χ	High impedance High impedance				
1	0	Χ	High impedance (shutdown)				

RECEIVING						
	INP	OUTPUT				
RE	DE	A - B	RO			
0	Χ	≥ -50mV	1			
0	Χ	≤ -200mV	0			
0	Х	Open/Short	1			
1	1	X	High impedance			
1	0	X	High impedance (shutdown)			

X = Don't care, shutdown mode, driver, and receiver outputs are in high impedance.

### Function Tables for the MAX13412E/MAX13413E

TRANSMITTING								
INPUTS OUTPUTS								
DI	DI A - B > V <sub>DT</sub> ACTION		Α	В				
0	X	Turn driver ON	0	1				
1	False	If driver was OFF, keep it OFF	High impedance	High impedance				
1	False	If driver was ON, keep it ON	1	0				
1	True	Turn driver OFF	High impedance	High impedance				

	RECEIVING								
		ОИТРИТ							
RE	A - B	DRIVER STATE	RECEIVER STATE	RO					
0	≥ -100mV	X	ON	1					
0	<u>&lt;</u> -100mV	X	ON	0					
1	X	ON	OFF	High impedance					
1	<u>&gt;</u> -100mV	OFF	ON	1					
1	<u>&lt;</u> -100mV	OFF	ON	0					

X = Don't care, shutdown mode, driver, and receiver outputs are in high impedance.

### Function Tables for the MAX13414E/MAX13415E

TRANSMITTING						
INPUT		OUTPUT				
DE/RE	DI	В А				
0	Χ	High impedance	High impedance			
1	1	0	1			
1	0	1	0			

RECEIVING					
INF	OUTPUT				
DE/RE	A - B	RO			
0	≥ -50mV	1			
0	<u>&lt;</u> -200mV	0			
0	Open/Short	1			
1	X	High impedance			

X = Don't care, shutdown mode, driver, and receiver outputs are in high impedance.

### **Detailed Description**

The MAX13410E–MAX13415E are half-duplex RS-485/RS-422-compatible transceivers optimized for isolated applications. These devices feature an internal LDO regulator, one driver, and one receiver. The internal LDO allows the part to operate from an unregulated +6V to +28V power supply. The AutoDirection feature reduces the number of optical isolators needed in isolated applications. Other features include ±15kV ESD protection (MAX13412E/MAX13413E only), ±14kV (MAX13410E/MAX13411E only) fail-safe circuitry, slew-rate limiting, and full-speed operation.

The MAX13410E–MAX13415E internal LDO generates a 5V  $\pm$ 10% power supply that is used to power its internal circuitry. The MAX13412E–MAX13415E bring the 5V to an output VREG that allows the user to power additional external circuitry with up to 20mA to further reduce external components. The MAX13410E/MAX13411E do not have a 5V output and come in industry-compatible pinouts. This allows easy replacement in existing designs.

The MAX13412E/MAX13413E feature Maxim's proprietary AutoDirection control. This architecture eliminates the need for the DE and RE control signals. In isolated applications, this reduces the cost and size of the system by reducing the number of optical isolators required.

The MAX13410E/MAX13412E/MAX13414E feature reduced slew-rate drivers that minimize EMI and reduce reflections caused by improperly terminated cables, allowing error-free transmission up to 500kbps. The MAX13411E/MAX13413E/MAX13415E are not slew-rate limited, allowing transmit speeds up to 16Mbps.

The MAX13410E–MAX13415E feature a 1/8-unit load receiver input impedance, allowing up to 256 transceivers on the bus. All driver outputs are protected to ±15kV ESD using the Human Body Model. These devices also include fail-safe circuitry, MAX13410E/MAX13411E/MAX13414E/MAX13415E, guaranteeing a logic-high receiver output when the receiver inputs are open or shorted. The receiver outputs a logic-high when the transmitter on the terminated bus is disabled (high impedance).

### Internal Low-Dropout Regulator

The MAX13410E–MAX13415E include an internal low-dropout regulator that allows it to operate from input voltages of up to +28V. The internal LDO has a set output voltage of 5V  $\pm 10\%$  that is used to power the internal circuitry of the device. The MAX13412E–MAX13415E offer the LDO output at the VREG output. This allows additional external circuitry to be powered without the need for additional external regulators. The VREG output can source up to 20mA.

When using these devices with high input voltages and heavily loaded networks, special care must be taken that the power dissipation rating of the package and the maximum die temperature of the device is not exceeded. Die temperature of the part can be calculated using the equation:

TDIE =  $[(\theta_{JC} + \theta_{CA}) \times P_{DISS}] + T_{AMBIENT}$ , where

TDIE = Temperature of the Die

 $\theta_{JC} = 6.0^{\circ}\text{C/W} = \text{Junction-to-Case Thermal Resistance}$ 

 $\theta_{CA}$  = Case-to-Ambient Thermal Resistance

 $\theta_{JA} = \theta_{JC} + \theta_{CA} = 52.0^{\circ}\text{C/W} = \text{Junction-to-Ambient}$  Thermal Resistance

PDISS = (ICC - VCC) + [(VCC - VREG) × IREG)] + [(VCC - VOD) × IDRIVER] = Power Dissipation of the Part

Tambient Temperature

Vcc = Voltage on the Vcc Input

Icc = Current in to Vcc

VREG = Voltage on the VREG Output

IREG = Current Drawn from the VREG Output

Vop = Voltage at the Driver Output (IVA - VBI)

IDRIVER = Current Driven Out of the Driver. Typically, this is the current through the termination resistor.

The absolute maximum rating of the die temperature of the MAX13410E–MAX13415E is +150°C. To protect the part from overheating, there is an internal thermal shutdown that shuts down the part when the die temperature reaches +150°C. To prevent damage to the part, and to prevent the part from entering thermal shutdown, keep the die temperature below +150°C, plus some margin. The circuit designer can minimize the die temperature by controlling the following parameters:

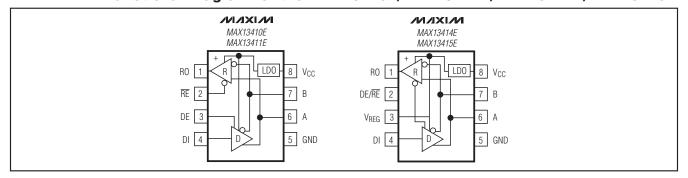
- Vcc
- IREG
- θCA

### Measuring the V<sub>CC</sub> Current

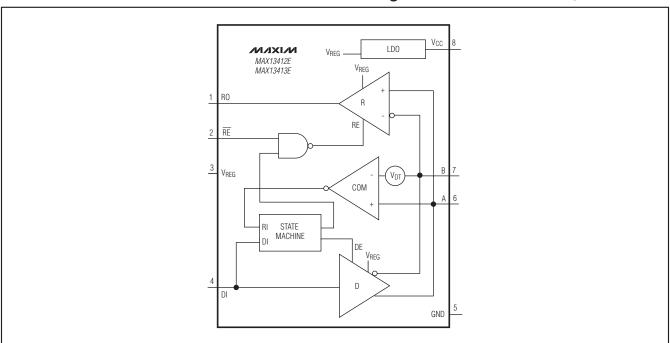
Measured current at the V<sub>CC</sub> pin is a function of the quiescent current of the part, the amount of current that the drivers must supply to the load, and in the case of the MAX13412E–MAX13415E, the load on the V<sub>REG</sub> output. In most cases, the load that the drivers must supply will be the termination resistor(s). Ideally, the termination resistance should match the characteristic impedance of the cable and is usually not a parameter the circuit designer can easily change. In some low-speed, short-cable applications, proper termination

Functional Diagrams

### Functional Diagram for the MAX13410E/MAX13411E/MAX13414E/MAX13415E



#### Functional Diagram for the MAX13412E/MAX13413E



may not be necessary. In these cases, the drive current can be reduced to minimize the die temperature.

Minimizing the load on the  $V_{\mbox{\scriptsize REG}}$  output lowers the power dissipation of the part and ultimately reduces the maximum die temperature.

 $\theta_{CA}$ 

 $\theta_{CA}$  is the thermal resistance from case to ambient and is independent of the MAX13410E–MAX13415E.  $\theta_{CA}$  is primarily a characteristic of the circuit-board design. The

largest contributing factor of  $\theta_{CA}$  will be the size and weight of the copper connected to the exposed paddle of the MAX13410E-MAX13415E. Lower the thermal resistance by using as large a pad as possible. Additionally, vias can be used to connect the pad to other ground planes in the circuit board.

Note that  $\theta_{\text{JC}}$  is the thermal resistance of the part from junction-to-case temperature and is fixed at 6.0°C/W. It is solely based on the die and package characteristics of

the MAX13410E–MAX13415E. The circuit-board designer has no control over this parameter.

#### Fail Safe

The MAX13410E/MAX13411E/MAX13414E/MAX13415E guarantee a logic-high receiver output when the receiver inputs are shorted or open, or when they are connected to a terminated transmission line with all drivers disabled. This is done by setting the receiver input threshold between -50mV and -200mV. If the differential receiver input voltage (A - B) is greater than or equal to -50mV. RO is logic-high. If (A - B) is less than or equal to -200mV, RO is logic-low. In the case of a terminated bus with all transmitters disabled, the receiver's differential input voltage is pulled to 0 by the termination. With the receiver thresholds of the MAX13410E/ MAX13411E/MAX13414E/MAX13415E, the result is a logic-high with a 50mV minimum noise margin. Unlike previous fail-safe devices, the -50mV to -200mV threshold complies with the ±200mV EIA/TIA-485 standard.

### **AutoDirection Circuitry**

The AutoDirection circuitry in the MAX13412E/MAX13413E is a technique to minimize the number of signals needed to drive the part. This is especially useful in very low cost, isolated systems. In a typical isolated system, an optocoupler is used for each control signal to cross the isolation barrier. These optocouplers add cost, size and consume power. Without the AutoDirection circuitry, three to four optocouplers may be required for each transceiver. With the AutoDirection circuitry, the number of optocouplers can be reduced to two.

Typical RS-485 transceivers have four signals on the control side of the part. These are RO (receiver output), RE (receiver enable), DE (driver enable), and DI (driver input). In some cases, DE and RE may be connected together to reduce the number of control signals to three. In half-duplex systems, the RE and DE signals determine if the part is transmitting or receiving. When the part is receiving, the transmitter is in a high-impedance state. In a fully compliant RS-485 system, all three or four signals are required. However, with careful design and Maxim's AutoDirection feature, the number of control signals can be reduced to just RO and DI in an RS-485 compatible system. This feature assumes the DI input idles in the high state while the receiver portion of the MAX13412E/MAX13413E is active. It also requires an external pullup resistor on A and pulldown resistor on B (see the typical application circuit, Figure 10). The following is a description of how AutoDirection works.

When DI is low, the MAX13412E/MAX13413E always drive the bus low. When DI transitions from a low to a

high, the drivers actively drive the output until (A - B) >  $V_{DT}$ . Once (A - B) is greater than  $V_{DT}$ , the drivers are disabled, letting the pullup/pulldown resistors hold the A and B lines in the correct state. This allows other transmitters on the bus to pull the bus low.

#### Pullup and Pulldown Resistors

The pullup and pulldown resistors on the A and B lines are required for proper operation of the MAX13412E and MAX13413E, although their exact value is not critical. They function to hold the bus in the high state (A - B > 200mV) when all the transmitters are in a high-impedance state due to either a shutdown condition or AutoDirection. Determining the best value to use for these resistors depends on many factors, such as termination resistor values, noise, number of transceivers on the bus, etc. Size these resistors so that, under all conditions, (A - B) > 200mV for ALL receivers on the bus.

#### Idle State

When not transmitting data, the MAX13412E/MAX13413E require the DI input to be driven high to remain in the idle state. A conventional RS-485 transceiver has DE and  $\overline{\text{RE}}$  inputs that are used to enable and disable the driver and receiver. However, the MAX13412E/MAX13413E do not have a DE input, and instead use an internal state machine to enable and disable the drivers. DI must be driven high to go to the idle state.

#### **Enhanced ESD Protection**

As with all Maxim devices, ESD-protection structures are incorporated on all pins to protect against electrostatic discharges encountered during handling and assembly. The driver outputs and receiver inputs of the MAX13410E–MAX13415E have extra protection against static electricity. Maxim's engineers have developed state-of-the-art structures to protect these pins against ESD of ±15kV (MAX13412E/MAX13413E) and ±14kV (MAX13410E/MAX13411E) without damage. The ESD structures withstand high ESD in all states: normal operation, shutdown, and powered down. After an ESD event, the MAX13410E–MAX13415E keep working without latchup or damage.

ESD protection can be tested in various ways. The transmitter outputs and receiver inputs of the MAX13410E–MAX13415E are characterized for protection to the following limits:

- ±15kV using the Human Body Model (MAX13412E/MAX13413E)
- ±14kV using the Human Body Model (MAX13410E/MAX13411E)

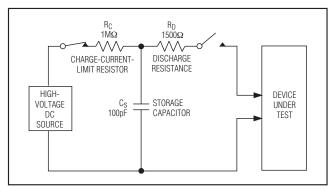


Figure 8a. Human Body ESD Test Model

#### **ESD Test Conditions**

ESD performance depends on a variety of conditions. Contact Maxim for a reliability report that documents test setup, test methodology, and test results.

#### **Human Body Model**

Figure 8a shows the Human Body Model, and Figure 8b shows the current waveform it generates when discharged into a low impedance. This model consists of a 100pF capacitor charged to the ESD voltage of interest, which is then discharged into the test device through a  $1.5 \mathrm{k}\Omega$  resistor.

# \_Applications Information

#### **Typical Applications**

The MAX13410E–MAX13415E transceivers are designed for half-duplex, bidirectional data communications on multipoint bus transmission lines. To minimize reflections, terminate the line at both ends in its characteristic impedance, and keep stub lengths off the main line as short as possible. The slew-rate-limited MAX13410E/MAX13412E/MAX13414E are more tolerant of imperfect termination.

#### Typical Application Circuit for the MAX13410E and MAX13411E

This application circuit shows the MAX13410E/MAX13411E being used in an isolated application (see Figure 9). The MAX13410E/MAX13411E use the industry-standard pin out but do not have a V<sub>REG</sub> output for biasing external circuitry. The positive temperature coefficient (PTC) and transient voltage suppressor (TVS) clamp circuit on the RS-485 outputs are intended to provide overvoltage fault protection and are optional based on the requirements of the design.

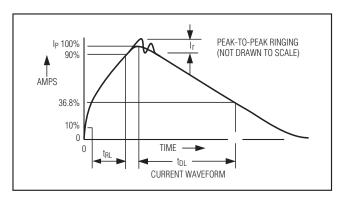


Figure 8b. Human Body Current Waveform

# Typical Application Circuit for the MAX13412E and MAX13413E

This application circuit shows the MAX13412E and MAX13413E being used in an isolated application where the AutoDirection feature is implemented to reduce the number of optical isolators to two (see Figure 10). The MAX13412E/MAX13413E provide a VREG output that can be used to power external circuitry up to 20mA.

# Typical Application Circuit for the MAX13414E and MAX13415E

This application circuit shows the MAX13414E/MAX13415E being used in an isolated application using an unregulated power supply with three optical isolators (see Figure 11). The MAX13414E/MAX13415E provide a VREG output that can be used to power external circuitry up to 20mA.

#### 256 Transceivers on the Bus

The RS-485 standard specifies the load each receiver places on the bus in terms of unit loads. An RS-485-compliant transmitter can drive 32 one-unit load receivers when used with a 120 $\Omega$  cable that is terminated on both ends over a -7V to +12V common-mode range. The MAX13410E–MAX13415E are specified as 1/8 unit loads. This means a compliant transmitter can drive up to 256 devices of the MAX13410E–MAX13415E. Reducing the common mode, and/or changing the characteristic impedance of the cable, changes the maximum number of receivers that can be used. Refer to the TIA/EIA-485 specification for further details.

#### Proper Termination and Cabling/ Wiring Configurations

When the data rates for RS-485 are high relative to the cable length it is driving, the system is subject to proper

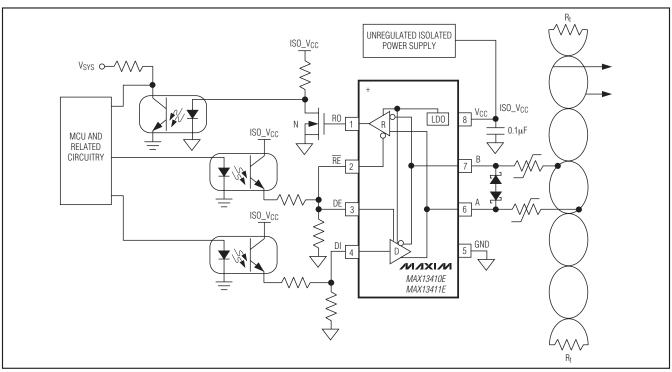


Figure 9. Typical Application Circuit for the MAX13410E/MAX13411E

transmission line design. In most cases, a single, controlled-impedance cable or trace should be used and should be properly terminated on both ends with the characteristic impedance of the cable/trace. RS-485 transceivers should be connected to the cable/ traces with minimum-length wires to prevent stubs. Star configurations and improperly terminated cables can cause data loss. Refer to the *Application Notes* section of the Maxim website or to TIA/EIA publication TSB-89-A for further information. While proper termination is always desirable, in some cases, such as when data rates are very low, it may be desirable and advantageous to not properly terminate the cables. In such cases, it is up to the designer to ensure that the improper termination and resultant reflections (etc.) will not corrupt the data.

#### **Reduced EMI and Reflections**

The MAX13410E/MAX13412E/MAX13414E feature reduced slew-rate drivers that minimize EMI and reduce reflections caused by improperly terminated cables, allowing error-free data transmission up to 500kbps.

### **Low-Power Shutdown Mode**

Low-power shutdown mode is initiated in the MAX13410E/MAX13411E by driving DE low and driving

RE high. In shutdown, the devices draw 65µA (typ) of supply current.

The devices are guaranteed not to enter shutdown if DE is low (while  $\overline{\text{RE}}$  is high) for less than 50ns. If the inputs are in this state for at least 700ns, the devices are guaranteed to enter shutdown.

Enable times tzH and tzL (see the switching characteristics table) assume the devices were not in a low-power shutdown state. Enable times tzH(SHDN) and tzL(SHDN) assume the devices were in shutdown state. It takes drivers and receivers longer to become enabled from low-power shutdown mode (tzH(SHDN), tzL(SHDN)) than from driver/receiver disable mode (tzH, tzL).

#### **Line Length**

The Telecommunications Industry Association (TIA) published the document TSB-89-A: *Application Guidelines for TIA/EIA-485-A*, which is a good reference for determining maximum data rate vs. line length.

#### **Isolated RS-485 Interface**

An isolated RS-485 interface electrically isolates different nodes on the bus to protect the bus from problems due to high common-mode voltages that exceed the RS-485 common-mode voltage range, conductive noise, and

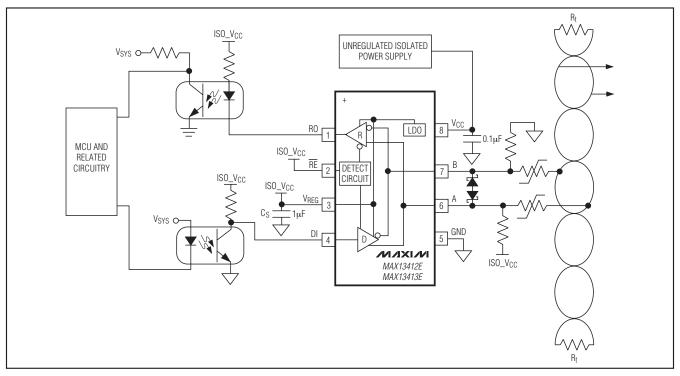


Figure 10. Typical Application Circuit for the MAX13412E/MAX13413E

ground loops. The typical application circuits show an isolated RS-485 interface using the MAX13410E–MAX13415E. The transceiver is powered separately from the controlling circuitry. The AutoDirection feature of the MAX13412E/MAX13413E (see the *AutoDirection Circuitry* section) requires only two optocouplers to electrically isolate the transceiver.

An isolated RS-485 interface electrically isolates different nodes on the bus to protect the bus from problems due to high common-mode voltages that exceed the RS-485 common-mode voltage range. An isolated RS-485 interface has two additional design challenges not normally associated with RS-485 design. These are 1) isolating the control signals and 2) getting isolated power to the transceiver. Optical isolators are the most common way of getting the control signals across the isolation barrier.

Isolated power is typically done using a transformer in either a push-pull or flyback configuration. The MAX845 is an example of an inexpensive, unregulated push-pull converter (see Figure 12). While in theory, the output of an unregulated push-pull converter is predictable, the output voltage can vary significantly due to the non-ideal

characteristics of the transformer, load variations, and temperature drift of the diodes, etc. Variances of  $\pm 20\%$  or more would not be uncommon. This would require the addition of a linear regulator to get standard RS-485 transceivers to work. Since the MAX13410E–MAX13415E have the linear regulator built in, this external regulator and its associated cost and size penalties are not necessary. A nominal +7.5V output with a  $\pm 20\%$  tolerance would provide a +6V to +9V supply voltage. This is well within the operating range of the MAX13410E–MAX13415E. If the output tolerance is even greater than  $\pm 20\%$ , adjust the design of the power supply for a higher output voltage to ensure the minimum input voltage requirements are met.

Flyback converters are typically regulated. A TL431 type error amplifier and an optical isolator usually close the loop. The MAX5021 is an example of a small, inexpensive, flyback controller (see Figure 13). While the primary output of the flyback converter is tightly regulated, secondary outputs will not be. As with the unregulated push-pull converter, the MAX13410E–MAX13415E are ideally suited for use with these secondary outputs.

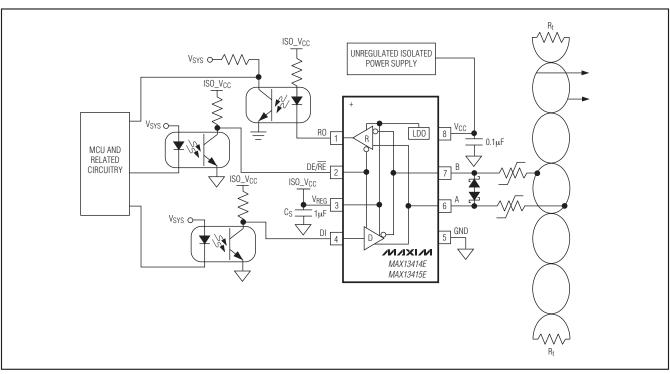


Figure 11. Typical Application Circuit for the MAX13414E/MAX13415E

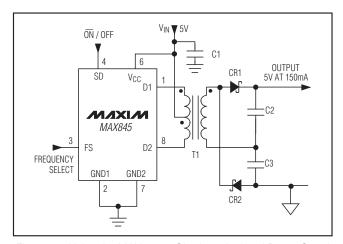


Figure 12. Using the MAX845 to Obtain an Isolated Power Supply

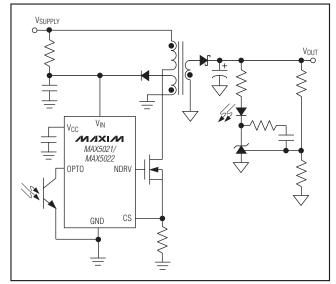
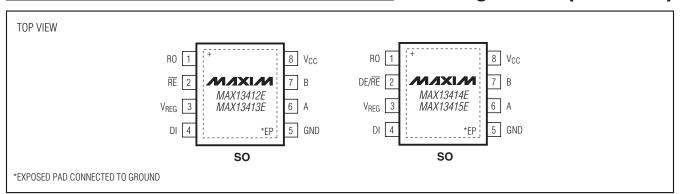


Figure 13. The MAX5021 and MAX5022 provide an isolated power supply with tighter regulation due to feedback using an opto-isolator coupler.

### Pin Configurations (continued)



### **Ordering Information/Selector Guide (continued)**

PART	PIN-PACKAGE	AutoDirection	DATA RATE (max)	5V LDO OUTPUT
MAX13412EESA+	8 SO-EP*	Yes	500kbps	Yes
MAX13413EESA+	8 SO-EP*	Yes	16Mbps	Yes
MAX13414EESA+**	8 SO-EP*	No	500kbps	Yes
MAX13415EESA+**	8 SO-EP*	No	16Mbps	Yes

**Note:** All devices operate over the -40°C to +85°C operating temperature range.

### **Chip Information**

PROCESS TECHNOLOGY: BICMOS

# Package Information

For the latest package outline information and land patterns, go to **www.maxim-ic.com/packages**. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	DOCUMENT NO.	
8 SO-EP	S8E+14	<u>21-0111</u>	

<sup>+</sup>Denotes a lead(Pb)-free/RoHS-compliant package.

<sup>\*</sup>EP = Exposed pad.

<sup>\*\*</sup>Future product—contact factory for availability.

### **Revision History**

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	11/07	Initial release.	_
1	8/09	Replaced Figure 9.	20

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